



0805Y0160561GCR Information



For Reference Only

Part Number 0805Y0160561GCR
Manufacturer Knowles Syfer
Category Capacitors

Ceramic Capacitors

Description CAP CER 0805 **Package** 0805 (2012 Metric)

For the pricing/inventory/lead time, please contact

us

Website: https://www.heisener.com E-mail: salesdept@heisener.com



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0805Y0160561GCR Specifications

Manufacturer Part Number 0805Y0160561GCR Manufacturer Knowles Syfer Category Capacitors Package 0805 (2012 Metric) Series FlexiCap? Capacitance 560pF Tolerance ±2% Voltage - Rated 16V Temperature Coefficient C0G, NP0 (1B) Operating Temperature -55°C ~ 125°C Features Soft Termination Ratings - Applications Boardflex Sensitive Failure Rate - Mounting Type Surface Mount, MLCC Package / Case 0805 (2012 Metric) Size / Dimension 0.079" L x 0.049" W (2.00mm x 1.25mm) Height - Seated (Max) - Thickness (Max) 0.051" (1.30mm) Lead Spacing - Lead Style -		
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Thickness (Max) 0.051" (1.30mm) Lead Spacing - Lead Style -	Size / Dimension	0.079" L x 0.049" W (2.00mm x 1.25mm)
Lead Spacing - Lead Style -	Height - Seated (Max)	-
Lead Style -	Thickness (Max)	0.051" (1.30mm)
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Report errors?	Lead Style	-
		Report errors?

0805Y0160561GCR Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

0805Y0160561GCR Payment Methods



















0805Y0160561GCR Shipping Methods













If you have any question about 0805Y0160561GCR, please do not hesitate to contact us!

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